

**Vishay Siliconix** 

## Automotive N-Channel 30 V (D-S) 175 °C MOSFET

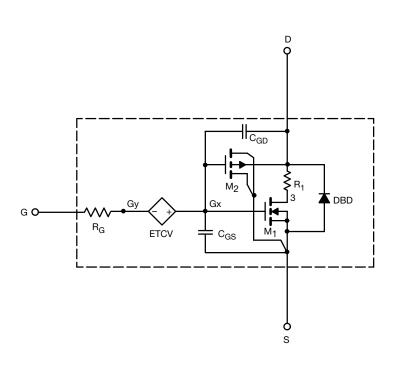
### DESCRIPTION

The attached SPICE model describes the typical electrical characteristics of the n-channel vertical DMOS. The subcircuit model is extracted and optimized over the - 55 °C to + 125 °C temperature ranges under the pulsed 0 V to 10 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage. A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C<sub>gd</sub> model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

#### SUBCIRCUIT MODEL SCHEMATIC

#### **CHARACTERISTICS**

- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- Apply for both Linear and Switching Application
- Accurate over the 55 °C to + 125 °C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics



#### Note

This document is intended as a SPICE modeling guideline and does not constitute a commercial product datasheet. Designers should refer to the appropriate datasheet of the same number for guaranteed specification limits.

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<b>SPECIFICATIONS</b> $T_J = 25 \text{ °C}$ , unless otherwise noted					
PARAMETER	SYMBOL	TEST CONDITIONS	SIMULATED DATA	MEASURED DATA	UNIT
Static	<u>.</u>				
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},\ I_{D}=250\ \mu A$	2	-	V
Drain-Source On-State Resistance <sup>a</sup>	Р	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10.3 \text{ A}$	0.0076	0.0075	Ω
	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8.7 \text{ A}$	0.012	0.011	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 16 A	45	56	S
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 10 A	0.76	0.80	V
Dynamic <sup>b</sup>	·				
Input Capacitance	C <sub>iss</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz	1560	1540	pF
Output Capacitance	C <sub>oss</sub>		547	560	
Reverse Transfer Capacitance	C <sub>rss</sub>		160	200	
Total Gate Charge	Qg	$V_{DS}$ = 15 V, $V_{GS}$ = 10 V, $I_{D}$ = 16.5 A	25	25	nC
Gate-Source Charge	Q <sub>gs</sub>		4	4	
Gate-Drain Charge	Q <sub>gd</sub>		5.4	5.4	

Notes

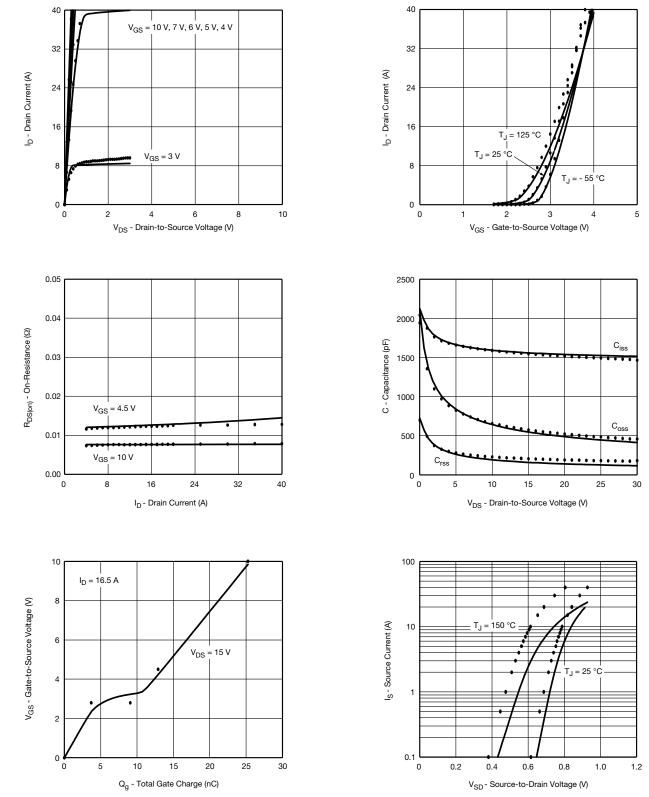
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.



## SPICE Device Model SQJ840EP

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## COMPARISON OF MODEL WITH MEASURED DATA $T_J$ = 25 °C, unless otherwise noted

#### Note

Dots and squares represent measured data.



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# Disclaimer

All product specifications and data are subject to change without notice.

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